



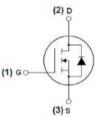
MJ N-Channel Enhancement Mode Power MOSFET

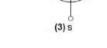
Description

The MJ30H14K uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.

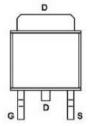
General Features

- ♦ Vps =30V.lp =140A $R_{DS(ON)}$ <3.0m Ω @ Vgs=10V $R_{DS(ON)} < 3.6 \text{m}\Omega \ @ V_{GS} = 4.5 \text{V}$
- ♦ High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high Eas
- Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability





Schematic diagram



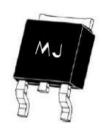
Application

◆ Power switching application

Uninterruptible power supply

Hard switched and high frequency circuits





TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ30H14K	MJ30H14K	TO-252-2L	4	-	9

Absolute Maximum Ratings (T_A =25 °Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vps	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	140	А
Drain Current-Continuous(Tc =100°C)	I D(100℃)	99	А
Pulsed Drain Current	Ірм	400	А
Maximum Power Dissipation	Po	130	W
Single pulse avalanche energy (Note 5)	Eas	400	mJ
Operating Junction and Storage Temperature Range	Тл ,Твтв	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rөjc	1.25	°C/W





Electrical Characteristics (TA =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	30	-	-	V
Zero Gate Voltage Drain Current	Ipss	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	Igss	V _{DS} =±20V,V _{DS} =0V	_	-	±100	nA
On Characteristics (Note 3)	-					
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250μA	1	1.6	2.5	V
Duein Course On Chale Desistence		V _{GS} =10V, I _D =20A	-	2.5	3.0	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =4.5V, I _D =20A	-	2.9	3.6	mΩ
Forward Transconductance	grs	V _{DS} =5V,I _D =20A	50	-	-	S
Dynamic Characteristics (Note 4)			1			
Input Capacitance	Clss		-	3780	-	PF
Output Capacitance	Coss	V _{DS} =15V,V _{GS} =0V F=1.0MHz	_	448	-	PF
Reverse Transfer Capacitance	Crss		_	410	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	tr	V _{GS} =10V,V _{DS} =15V R _L =0.75Ω,R _{GEN} =3Ω	-	16	-	nS
Turn-Off Delay Time	t _{d(off)}		_	42	-	nS
Turn-Off Fall Time	tf		_	12	-	nS
Total Gate Charge	Qg		-	80	-	nC
Gate-Source Charge	Qgs	V _{GS} =10V,V _{DS} =15V I _D =20A	-	12.4	-	nC
Gate-Drain Charge	Q _{gd}	-	-	18.3	-	nC
Drain-Source Diode Characteristics		I				l
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		_	-	140	А
Reverse Recovery Time	trr	TJ=25°C, IF=20A	_	58	-	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	-	115	-	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is no	egligible(tu	rn-on is d	ominated b	v LS+LD

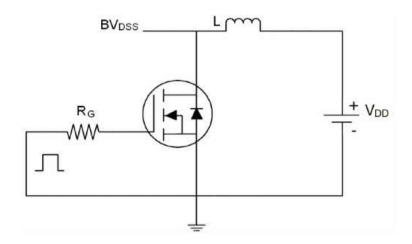
Notes:

- 1 Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production
- (§) EAS condition: Tj=25°C,VDD=15V,VG=10V,L=0.5mH,Rg=25 Ω

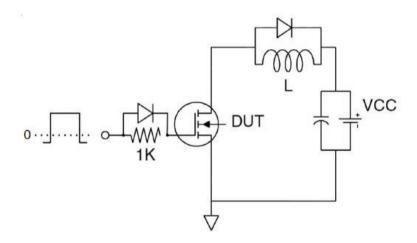




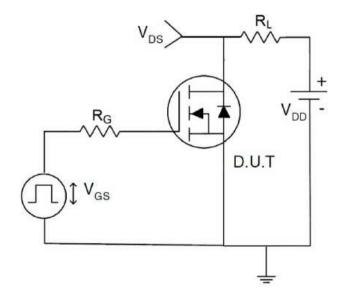
Test circuit



Eas test Circuit



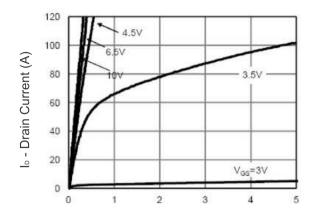
Gate charge test Circuit



Switch Time Test Circuit

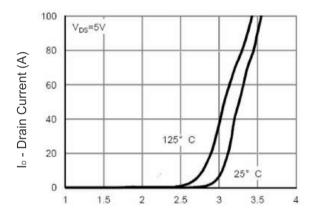


Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

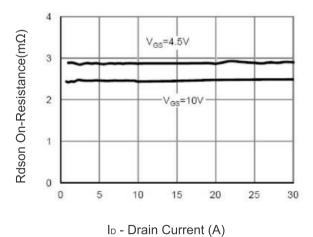
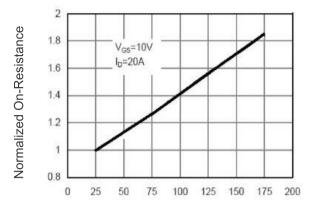
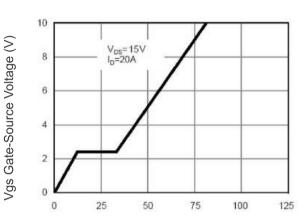


Figure 3 Rdson- Drain Current

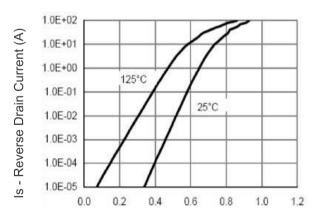


T_J -Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature



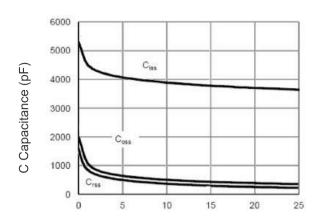
Qg Gate Charge (nC) Figure 5 Gate Charge



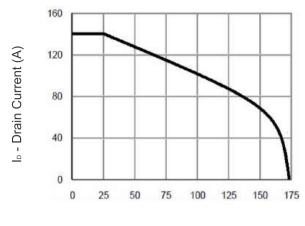
Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward

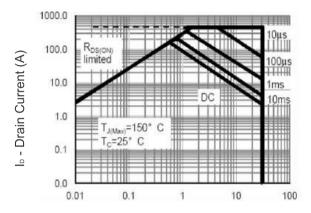




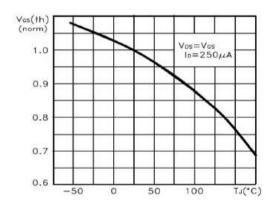
Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds



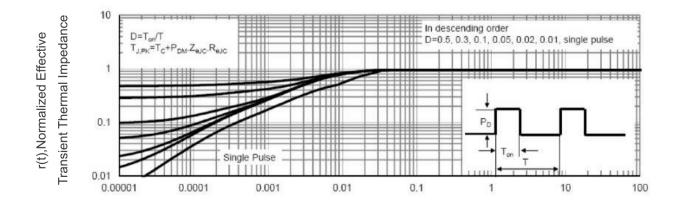
T_J -Junction Temperature(°C)
Figure 9 Current De-rating



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area



T_J -Junction Temperature(°C)
Figure 10 V_{GS(th)} vs Junction Temperature



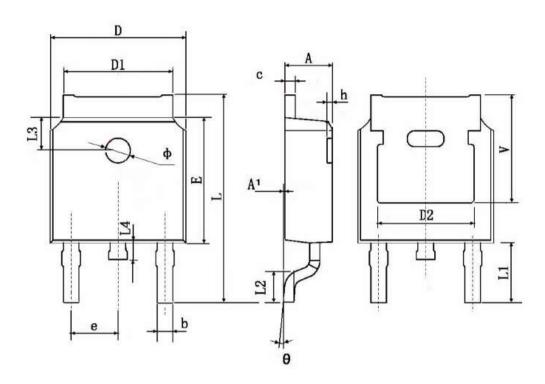
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900	TYP.	0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211	TYP.





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